



## Material Content Data Sheet



Halogen-Free

<b>Sales Product Name</b>	ESD1P0RFW H6327	<b>Issued</b>	01. May 2021
<b>MA#</b>	MA000845586		
<b>Package</b>	PG-SOT323-3-1	<b>Weight*</b>	5.96 mg

Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	arsenic	7440-38-2	0.000			7	
	noble metal	gold	7440-57-5	0.004	0.07		678	
	inorganic material	silicon	7440-21-3	0.035	0.58	0.65	5794	6479
leadframe	inorganic material	silicon	7440-21-3	0.001	0.01		88	
	non noble metal	titanium	7440-32-6	0.003	0.04		441	
	non noble metal	chromium	7440-47-3	0.008	0.13		1324	
	non noble metal	copper	7440-50-8	2.617	43.92	44.10	439334	441187
wire	non noble metal	copper	7440-50-8	0.004	0.07	0.07	688	688
encapsulation	organic material	carbon black	1333-86-4	0.031	0.53		5277	
	plastics	epoxy resin	-	0.676	11.35		113453	
	inorganic material	silicondioxide	60676-86-0	2.436	40.90	52.78	408957	527687
leadfinish	non noble metal	tin	7440-31-5	0.133	2.23	2.23	22278	22278
plating	noble metal	silver	7440-22-4	0.010	0.17	0.17	1681	1681
*deviation	< 10%				Sum in total:	100.00		1000000

### Important Remarks:

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